

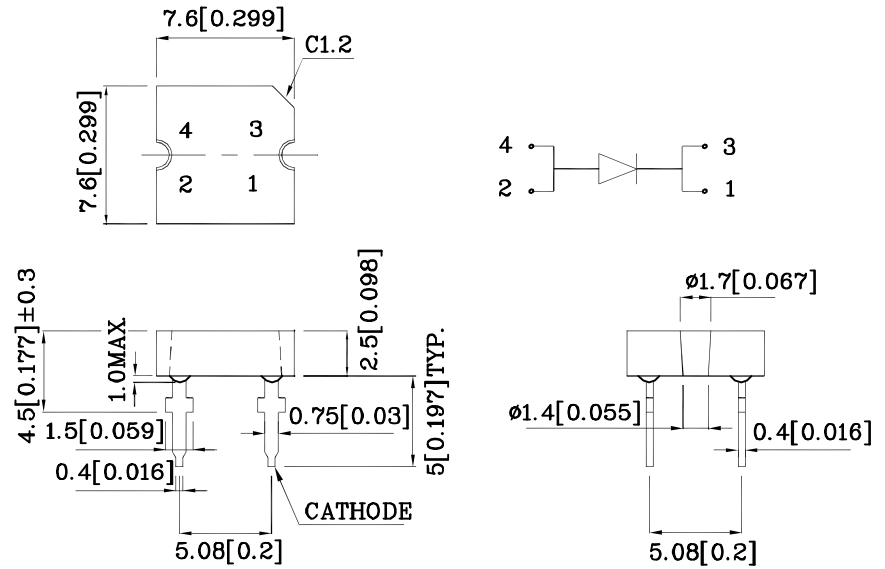
Features

- High current operation for greater luminous output
- Low power consumption and thermal resistance
- Can be used with automatic insertion equipment
- RoHS Compliant



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



Notes:

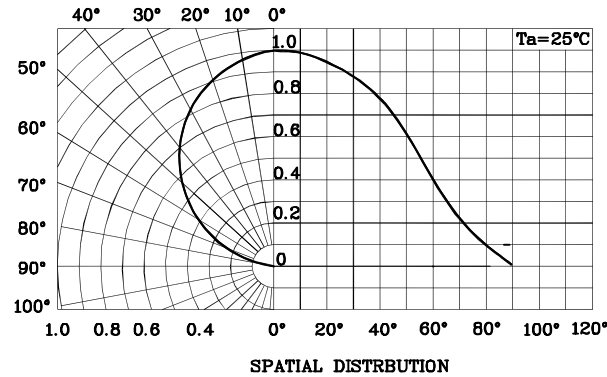
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		FWCA (InGaN)	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	100	mA
Power Dissipation	P _D	126	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		250	V
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

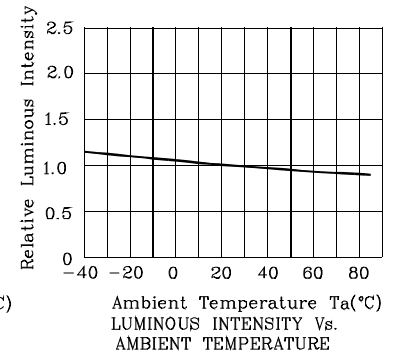
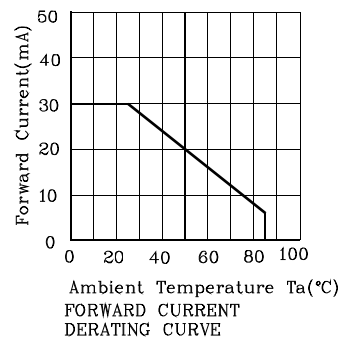
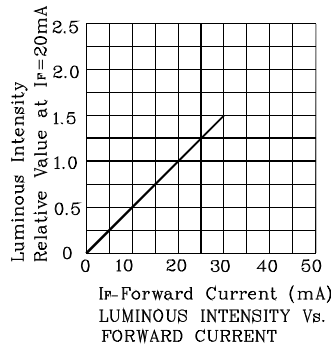
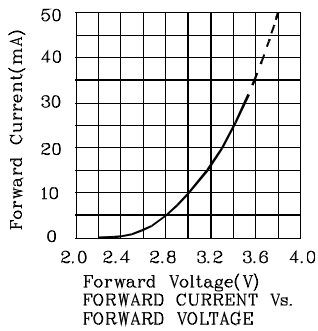
Operating Characteristics (T _A =25°C)		FWCA (InGaN)	Unit
Forward Voltage (Typ.) (I _F =30mA)	V _F	3.5	V
Forward Voltage (Max.) (I _F =30mA)	V _F	4.2	V
Reverse Current (Max.) (V _R =5V)	I _R	50	µA
Chromaticity Coordinates (Typ.)	x	0.31	
	y	0.31	
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Luminous Flux CIE127-2007* (I _F =20mA) mlm	Viewing Angle 2θ 1/2
				min.	typ.		
XSFWCA383W	White	InGaN	Water Clear	500*	1000*	2500*	110°

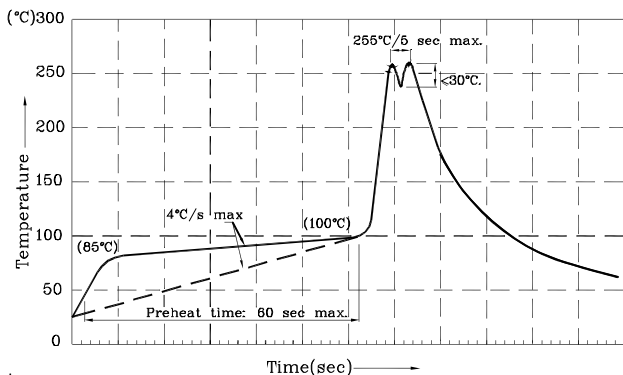
1. θ 1/2 Is the angle from optical centerline where the luminous intensity is 1/2 the optical peak value.
 2. Drive current between 10mA and 30mA are recommended for long term performance.
 3. Operation at current below 10mA is not recommended.
 4. LEDs are binned according to their Luminous intensity.
- *Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.



❖ FWCA



Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or chromaticity), the typical accuracy of the sorting process is as follows:

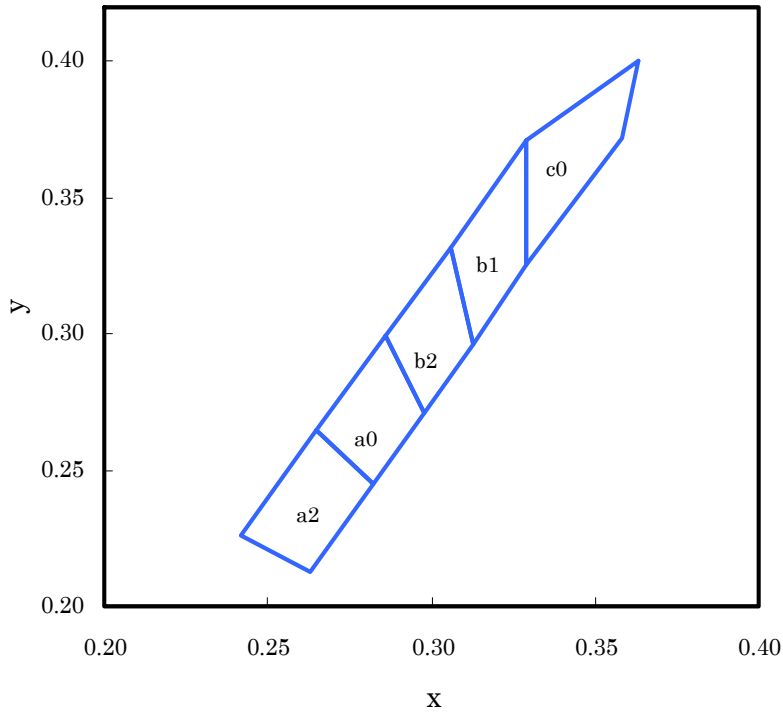
1. Measurement tolerance of the chromaticity coordinates is ± 0.01 .
2. Luminous Intensity/ Luminous Flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1V$

Note: Accuracy may depend on the sorting parameters.



XSFWCA383W

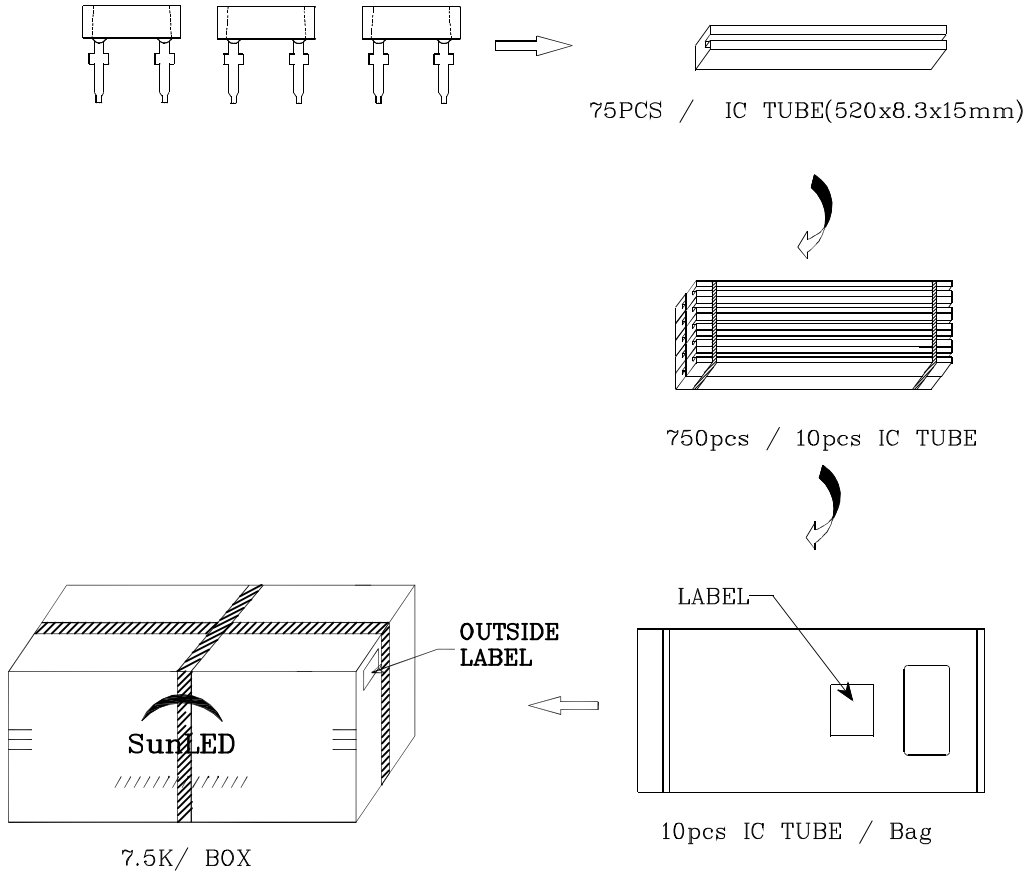

White CIE

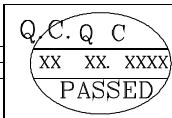



	x	y		x	y		x	y
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

Notes:
Shipment may contain more than one chromaticity regions.
Orders for single chromaticity region are generally not accepted.
Measurement tolerance of the chromaticity coordinates is ± 0.01 .

PACKING & LABEL SPECIFICATIONS

	
P/NO : XSxxx383x	
QTY : 750 pcs	CODE: XXX
S/N : XX	
LOT NO:	
 XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	